

AFE49I30 Ultra-Small, Integrated AFE With FIFO for Multi-Sensor Wearable, Optical Heart-Rate Monitoring and Bio-sensing

1 Features

- Supports signal acquisition of up to 24 phases
- Flexible allocation of 6 LED, 4 PD in each PPG phase
- Synchronized PPG/ECG signal acquisition with each phase configurable as PPG or ECG, and at different data rates
- Synchronized PPG/ECG supports up to 1 kHz data rate
- ECG-only mode supports up to 4 kHz data rate
- PPG signal chain:
 - System SNR up to 108-dB at 16 μ A PD current
 - Low current for continuous operation on a wearable device with a typical value: 15 μ A for an LED, 20 μ A for the receiver
- PPG Transmitter:
 - Supports common anode LED configuration
 - 8-Bit programmable LED current with range adjustable from 25 mA to 250 mA
 - Mode to fire two LEDs in parallel with independent per-phase current control
 - Programmable LED on-time per-phase
 - Simultaneous support of 6 LEDs for SpO₂, HRM, or multi-wavelength HRM
- PPG Receiver:
 - Supports 4 time-multiplexed photodiode inputs
 - 2 parallel receivers to sample two PD channels simultaneously
 - Individual ambient offset subtraction DAC at each TIA Input with 8-bit per-phase control and range adjustable up to 255- μ A
 - Individual LED offset subtraction DAC at each TIA input with 5-bit per-phase control and 15.5- μ A range
 - Close to 100 dB ambient rejection up to 10 Hz
 - Noise filtering with programmable bandwidth
 - Transimpedance Gain: 3.7 k Ω to 1 M Ω
- ECG Signal Chain
 - 1-lead ECG with RLD output for bias
 - INA gain programmable from 1.6 – 13
 - <1 μ Vrms input noise (in a 1-150 Hz bandwidth) at 4-kHz sample rate
 - Integrated 450 Hz Low Pass Filter
 - AC, DC lead-off detect with 3.125-100 nA current and programmable interrupt

- Supports external clock and internal oscillator modes
- Option to acquire data synchronized with a system master clock
- Automatic cancellation of DC from ambient, LED
- FIFO with 128-sample depth
- I²C interface
- 2.6-mm x 2.1-mm DSBGA, 0.4-mm pitch
- Supplies: Rx: 1.7 V-1.9 V (LDO bypass); 1.9 V-3.6 V (LDO enabled), Tx: 3 V-5.5 V, IO: 1.7-3.6 V
- Supports operation with 2 supplies - 1.8 V, 5 V

2 Applications

- ECG on a wearable device
- Synchronized PPG, ECG for PTT-based Blood pressure
- Optical heart-rate monitoring (HRM) and Heart-rate variability (HRV) for wearables, hearables
- Pulse oximetry (SpO₂) measurements
- Maximum oxygen consumption (VO₂ Max)

3 Description

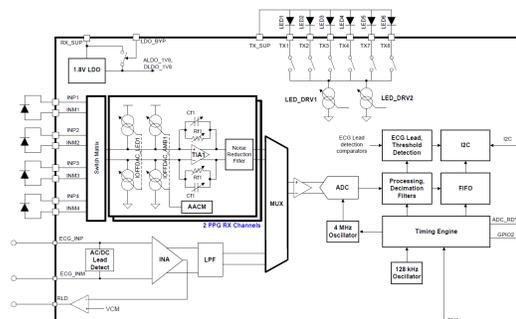
The AFE49I30 is an analog front-end for optical bio-sensing/ PPG and ECG measurement applications. The device supports up to six switching light-emitting diodes (LEDs) and up to four photodiodes. Up to 24 signal phases can be defined and the PPG or ECG signals can be acquired from each phase in a synchronized manner.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)
AFE49I30	DSBGA (30)	2.60 mm x 2.10 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Simplified Schematic



4 Device and Documentation Support

4.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

4.2 Support Resources

TI E2E™ [support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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4.3 Trademarks

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4.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

4.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

5 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
AFE49I30YZR	Active	Production	DSBGA (YZ) 30	3000 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	AFE49I30
AFE49I30YZR.A	Active	Production	DSBGA (YZ) 30	3000 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	AFE49I30
AFE49I30YZT	Active	Production	DSBGA (YZ) 30	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	AFE49I30
AFE49I30YZT.A	Active	Production	DSBGA (YZ) 30	250 SMALL T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	AFE49I30

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

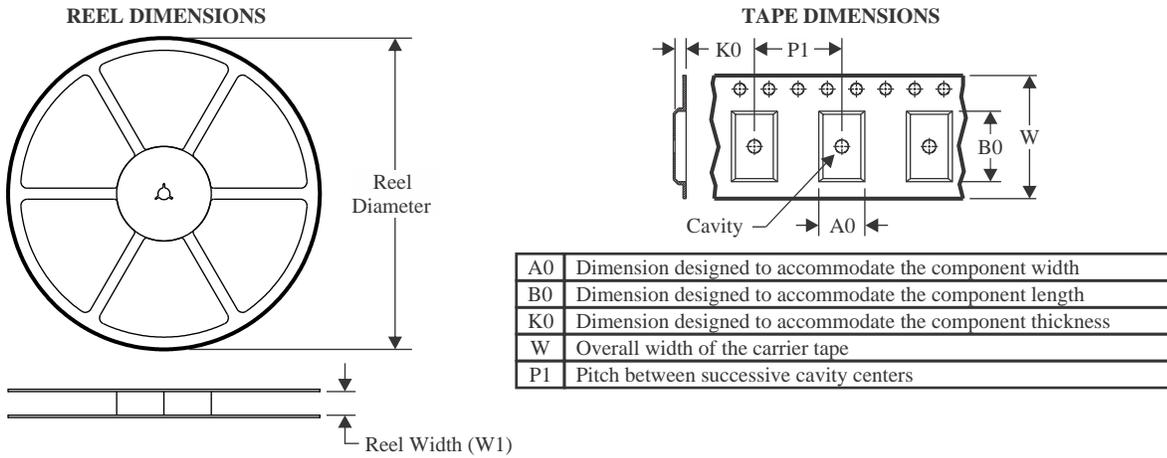
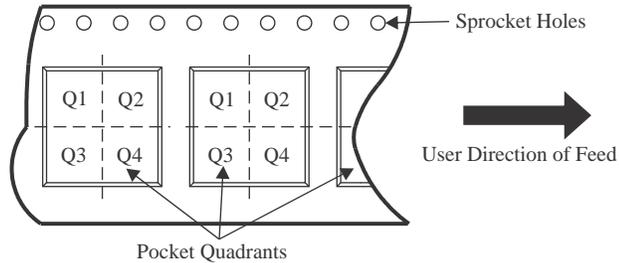
(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

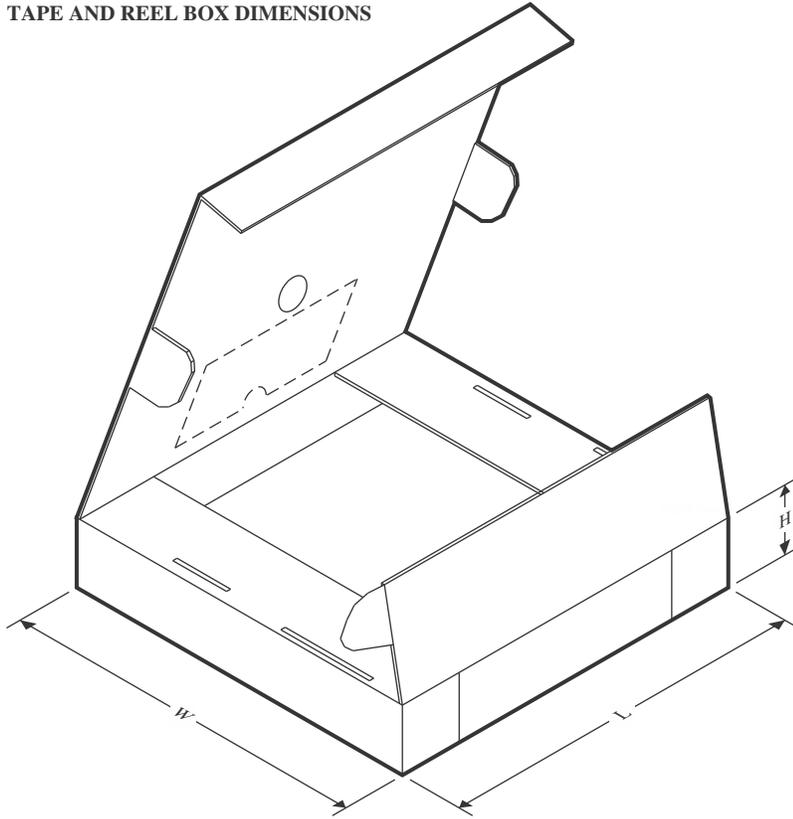
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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
AFE49I30YZR	DSBGA	YZ	30	3000	180.0	8.4	2.26	2.74	0.81	4.0	8.0	Q1
AFE49I30YZT	DSBGA	YZ	30	250	180.0	8.4	2.26	2.74	0.81	4.0	8.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
AFE49I30YZR	DSBGA	YZ	30	3000	210.0	185.0	35.0
AFE49I30YZT	DSBGA	YZ	30	250	210.0	185.0	35.0

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